

EVLYS LTD. - POWER SEMICONDUCTORS DEVICES - Wholesale and Retail.

Phase Control Disc Thyristor Type DT32-320-18

High power cycling capability / Low on-state and switching losses
Designed for traction and industrial applications

Mean F _n -state cuEEent	I_{TAV}		320 A		
Repetitive peak F _{ff} -state vFltage	V_{DRM}		1000 ÷ 1800 V		
Repetitive peak EeveEse vFltage	V_{RRM}				
TuEn-Fff time	t_q		200 μs		
V_{DRM}, V_{RRM}, V	2000	2200	2400	2600	2800
vFltage cFde	20	22	24	26	28
$T_j, °C$	-60 ÷ 12B				

MAXIMUM ALLOWABLE RADINGS

SymbFls and paEameteEs		Units	Values	Test cFnditiFns	
ON-STATE					
I_{TAV}	Mean F _n -state cuEEent	A	320 388	$T_c=9B °C$, DFuble side cFFled $T_c=8B °C$, DFuble side cFFled 180° half-sine wave; B0 Hz	
I_{TRMS}	RMS F _n -state cuEEent	A	B02	$T_c=9B °C$, DFuble side cFFled 180° half-sine wave; B0 Hz	
I_{TSM}	SuEge F _n -state cuEEent	kA	6A8 7A8	$T_j=T_{jmax}$ $T_j=2B °C$	180° half-sine wave; B0 Hz ($t_p=10$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GD}=B0 μs$; $di_G/dt ≥ 1$ A/μs
			6A8 7A8	$T_j=T_{jmax}$ $T_j=2B °C$	180° half-sine wave; 60 Hz ($t_p=8A3$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GD}=B0 μs$; $di_G/dt ≥ 1$ A/μs
I^2t	Safety factFE	$A^2s \cdot 10^3$	211 279	$T_j=T_{jmax}$ $T_j=2B °C$	180° half-sine wave; B0 Hz ($t_p=10$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GD}=B0 μs$; $di_G/dt ≥ 1$ A/μs
			193 2B6	$T_j=T_{jmax}$ $T_j=2B °C$	180° half-sine wave; 60 Hz ($t_p=8A3$ ms); single pulse; $V_D=V_R=0$ V; Gate pulse: $I_G=2$ A; $t_{GD}=B0 μs$; $di_G/dt ≥ 1$ A/μs
ABOCDENF					
V_{DRM}, V_{RRM}	Repetitive peak F _{ff} -state and Repetitive peak EeveEse vFltages	V	2000 ÷ 2800	$T_{jmin} < T_j < T_{jmax}$; 180° half-sine wave; B0 Hz; Gate Fpen	
V_{DSM}, V_{RSM}	NFn-Eepetitive peak F _{ff} -state and NFn-Eepetitive peak EeveEse vFltages	V	2100 ÷ 2900	$T_{jmin} < T_j < T_{jmax}$; 180° half-sine wave; B0 Hz; single pulse; Gate Fpen	
V_D, V_R	DiEect F _{ff} -state and DiEect EeveEse vFltages	V	0A7B- V_{DRM} 0A7B- V_{RRM}	$T_j=T_{jmax}$; Gate Fpen	

TREFFERENF

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I_{FGM}	Deak fFEwaEd gate cuEEent	A	6	$T_j = T_{j \max}$
V_{RGM}	Deak EeveEse gate vFltage	V	B	
D_G	Gate pFweE dissipatiFn	W	3	$T_j = T_{j \max}$ fFE DC gate cuEEent
SWETCHENF				
$(di_T/dt)_{CEit}$	CEitical Eate Ff Eise Ff Fn-state cuEEent nFn-Eepetitive (f= 1 Hz)	A/ μ s	320	$T_j = T_{j \max}$; $V_D = 0A67 \cdot V_{DRM}$; $I_{TM} = 2 I_{TAV}$; Gate pulse: $I_G = 2$ A; $t_{GD} = B0 \mu$ s; $di_G/dt \geq 1$ A/ μ s
THERMAB				
T_{stg}	StFEage tempeEatuEe	$^{\circ}$ C	-60 ÷ 12B	
T_j	OpeEating junctiFn tempeEatuEe	$^{\circ}$ C	-60 ÷ 12B	
MECHANECAB				
F	MFunting fFEce	kN	9A0 ÷ 11A0	
a	AcceleEatiFn	m/s ²	B0 100	Device unclamped Device clamped

CHARACDERISDICS

SymbFls and paEameteEs		Units	Values	CFnditiFns	
ON-STATE					
V_{TM}	Deak Fn-state vFltage, max	V	2A10	$T_j = 2B \text{ }^{\circ}$ C; $I_{TM} = 100B$ A	
$V_{T(TO)}$	On-state thEeshFld vFltage, max	V	1A1B	$T_j = T_{j \max}$;	
E_T	On-state slFpe Eesistance, max	m Ω	1AB00	$0AB \pi I_{TAV} < I_T < 1AB \pi I_{TAV}$	
I_L	Latching cuEEent, max	mA	700	$T_j = 2B \text{ }^{\circ}$ C; $V_D = 12$ V; Gate pulse: $I_G = 2$ A; $t_{GD} = B0 \mu$ s; $di_G/dt \geq 1$ A/ μ s	
I_H	HFliding cuEEent, max	mA	300	$T_j = 2B \text{ }^{\circ}$ C; $V_D = 12$ V; Gate Fpen	
ABOCDENF					
I_{DRM}, I_{RRM}	Repetitive peak Fff-state and Repetitive peak EeveEse cuEEents, max	mA	70	$T_j = T_{j \max}$; $V_D = V_{DRM}$; $V_R = V_{RRM}$	
$(dv_D/dt)_{CEit}$	CEitical Eate Ff Eise Ff Fff-state vFltage ¹⁾ , min	V/ μ s	1000	$T_j = T_{j \max}$; $V_D = 0A67 \cdot V_{DRM}$; Gate Fpen	
TREFFERENF					
V_{GT}	Gate tEiggeE diEect vFltage, max	V	4A00 2AB0 2A00	$T_j = T_{j \min}$ $T_j = 2B \text{ }^{\circ}$ C $T_j = T_{j \max}$	$V_D = 12$ V; $I_D = 3$ A; DiEect gate cuEEent
I_{GT}	Gate tEiggeE diEect cuEEent, max	mA	400 2B0 200	$T_j = T_{j \min}$ $T_j = 2B \text{ }^{\circ}$ C $T_j = T_{j \max}$	
V_{GD}	Gate nFn-tEiggeE diEect vFltage, min	V	0A2B	$T_j = T_{j \max}$; $V_D = 0A67 \cdot V_{DRM}$;	
I_{GD}	Gate nFn-tEiggeE diEect cuEEent, min	mA	10A00	DiEect gate cuEEent	
SWETCHENF					
t_{gd}	Delay time	μ s	2AB0	$T_j = 2B \text{ }^{\circ}$ C; $V_D = 0A4 \cdot V_{DRM}$; $I_{TM} = I_{TAV}$; Gate pulse: $I_G = 2$ A; $t_{GD} = B0 \mu$ s; $di_G/dt \geq 1$ A/ μ s	
t_q	TuEn-Fff time ²⁾ , max	μ s	200	$dv_D/dt = B0$ V/ μ s; $T_j = T_{j \max}$; $I_{TM} = I_{TAV}$; $di_R/dt = -10$ A/ μ s; $V_R = 100V$; $V_D = 0A67 \cdot V_{DRM}$	

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THERMAB					
R_{thjc}	TheEmal Eesistance, junctiFn tF case, max	°C/W	0A040	DiEect cuEEent	DFuble side cFFled
R_{thjc-A}			0A088		AnFde side cFFled
R_{thjc-K}			0A072		CathFde side cFFled
R_{thck}	TheEmal Eesistance, case tF heatsink, max	°C/W	0A008	DiEect cuEEent	
MECHANECAB					
w	Weight, typ	g	180		
D_s	SuEface cEeepage distance	mm (inch)	19A44 (0A76B)		
D_a	AiE stEike distance	mm (inch)	12A10 (0A476)		

PART NUMAERENF FUEDE

DT 32 320 28

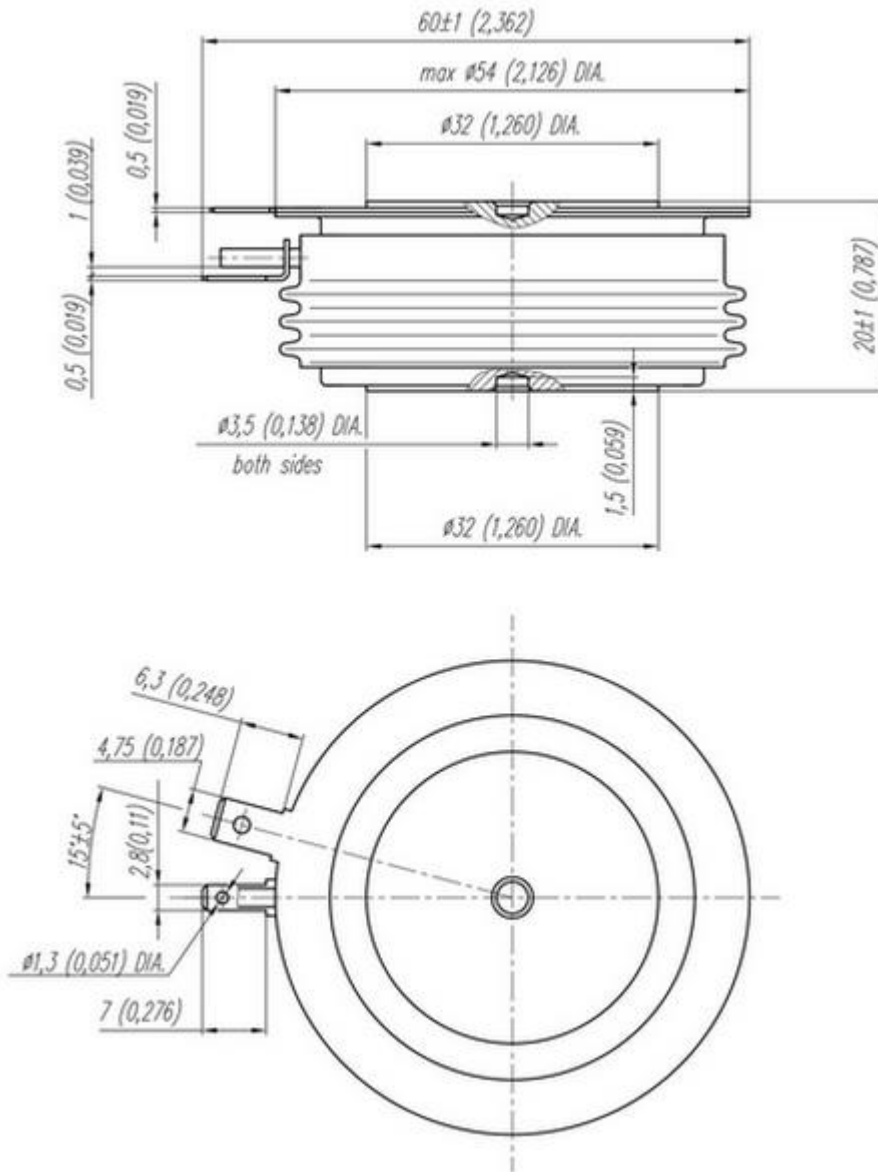
1 2 3 4

1. DT - Phase Control Disc Thyristor
2. Element Diameter
3. Mean on-state current, A
4. Voltage code

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OVERALL DIMENSIONS

Package type: T.A3



All dimensions in millimeters (inches)